ETR38002-001

#### Switching Diode

#### **■**FEATURES

**Small Package** 

Environmentally Friendly : EU RoHS Compliant, Pb Free

#### ■ APPLICATIONS

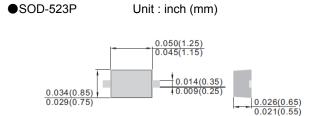
High-speed Switching

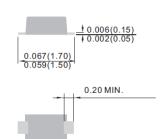
#### **■PRODUCT NAME**

PRODUCT NAME	PACKAGE	ORDER UNIT
XBW1SS400-G *	SOD-523P	5,000pcs/Reel

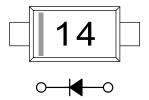
<sup>\*</sup> The "-G" suffix denotes Halogen and Antimony free as well as being fully EU RoHS compliant

#### ■ PACKAGING INFORMATION





#### ■ MARKING



### ■ ABSOLUTE MAXIMUM RATINGS

Ta=25°C

PARAMETER	SYMBOL	RATINGS	UNIT
Reverse Voltage (DC)	$V_{R}$	80	V
Peak Reverse Voltage	$V_{RM}$	90	V
Forward Current (Average)	$I_{F(AV)}$	100	mA
Peak Forward Surge Current (t=1µs)	I <sub>FSM</sub>	2	Α
Power Dissipation	Pd	200 (*1)	mW
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	-55 to +150	°C

<sup>(\*1)</sup> PCB mounted

#### ■ ELECTRICAL CHARACTERISTICS

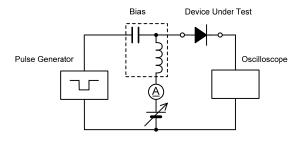
Ta=25°C

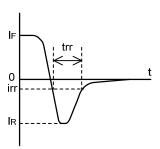
PARAMETER SYMBOL	O)/MDOI	TEST CONDITIONS	LIMITS			LINUT
	STIMBUL		MIN.	TYP.	MAX.	UNIT
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =100mA			1.20	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =80V	-	-	0.1	μA
Terminal Capacitance	Ct	V <sub>R</sub> =0V, f=1MHz	-	0.5	-	pF
Reverse Recovery Time	trr	$I_F=I_R=10$ mA, irr=1mA, $R_L=100\Omega$	-	4	-	ns

# XBW1SS400-G

#### **■** MEASUREMENT CIRCUITS

#### ●Reverse Recovery Time





## ■NOTES ON USE

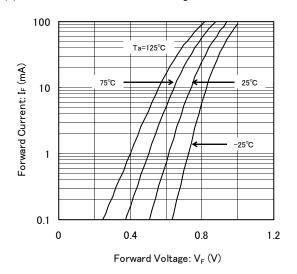
- 1. Please use this IC within the absolute maximum ratings.

  Even within the ratings, in case of high load use continuously such as high temperature, high voltage, high current and thermal stress may cause reliability degradation of the IC.
- 2. Torex places an importance on improving our products and their reliability.

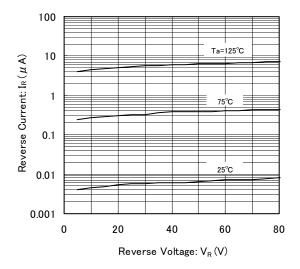
  We request that users incorporate fail-safe designs and post-aging protection treatment when using Torex products in their systems.

#### **■**TYPICAL PERFORMANCE CHARACTERISTICS

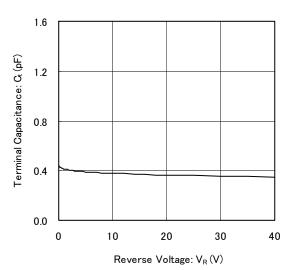
(1) Forward Current vs. Forward Voltage



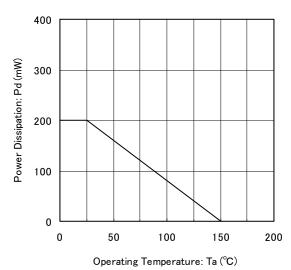
(2) Reverse Current vs. Reverse Voltage



(3) Terminal Capacitance vs. Reverse Voltage



(4) Power Dissipation vs. Operating Temperature

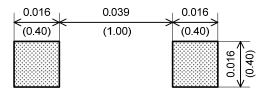


# XBW1SS400-G

## ■ REFERENCE PATTERN LAYOUT

●SOD-523P

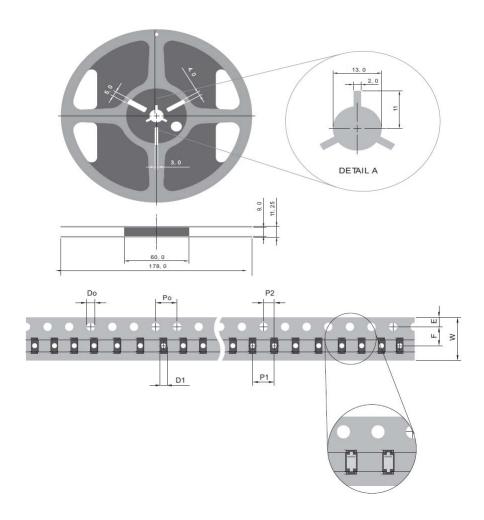
Unit: inch (mm)



# ■TAPING SPECIFICATIONS

#### ●SOD-523P

Unit : mm



SYMBOL	_ mm
D <sub>0</sub>	1.50 ± 0.10
D1	0.50 ± 0.25
Е	1.75 ± 0.10
F	$3.50 \pm 0.05$
P <sub>0</sub>	4.00 ± 0.10
P1	4.00 ± 0.10
P2	2.00 ± 0.05
W	8.00 + 0.3 - 0.15

- 1. The product and product specifications contained herein are subject to change without notice to improve performance characteristics. Consult us, or our representatives before use, to confirm that the information in this datasheet is up to date.
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- 5. Although we make continuous efforts to improve the quality and reliability of our products; nevertheless Semiconductors are likely to fail with a certain probability. So in order to prevent personal injury and/or property damage resulting from such failure, customers are required to incorporate adequate safety measures in their designs, such as system fail safes, redundancy and fire prevention features.
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